

Product Change Notification

Change Title	DDR4 product change notice from Micron 3200 1Gx8 E die WT IC to Micron 3200 1Gx8 R die WT IC	Date	2023/05/29	PCN No	23052401
PCN level:	Major				
Models :	Innodisk DDR4 3200 Micron 1Gx8 E die WT IC DRAM Module products				
Category:	Hardware - IC				

Key Characteristics of the Change:

Due to supply conditions, Innodisk hereby announces the product change plan for all DDR4 3200 Micron 1Gx8 E die WT IC assembled modules

Description:

Innodisk will process DDR4 3200 Micron 1Gx8 E die WT IC product termination and run the change to DDR4 3200 1Gx8 R die WT IC product series.
Affected items include: DDR4 8GB/16GB SODIMM/UDIMM/ECC SODIMM/ECC UDIMM/UDIMM VLP (all wide temperature)

Key Milestone Dates

Last Purchase Date: 2023/08/31

Last Shipment Date: 2023/11/30

*Milestone dates are subject to change based on business and operational conditions.

Affected Model Table

#	Current Part Number	New Part Number
1	M4CE-8GM1LWSJ-E	M4CE-8GM1LWSJ-R
2	M4DE-8GM1PW0M-E	M4DE-8GM1PW0M-R
3	M4DE-8GM1PWIK-E	M4DE-8GM1PWIK-R
4	M4DE-8GM1PWSJ-E	M4DE-8GM1PWSJ-R
5	M4DE-AGM1QWIK-E	M4DE-AGM1QWIK-R
6	M4DE-AGM1QWRG-E	M4DE-AGM1QWRG-R
7	M4DE-AGM1QWSJ-E	M4DE-AGM1QWSJ-R
8	M4RE-AGM1BWIK-E	M4RE-AGM1BWIK-R
9	M4SE-8GM1NIIK-E	M4SE-8GM1NIIK-R
10	M4SE-8GM1NIRG-E	M4SE-8GM1NIRG-R
11	M4SE-8GM1NISJ-E	M4SE-8GM1NISJ-R
12	M4SE-AGM1OI0M-E	M4SE-AGM1OI0M-R
13	M4SE-AGM1OI1K-E	M4SE-AGM1OI1K-R
14	M4SE-AGM1OI1R-E	M4SE-AGM1OI1R-R
15	M4SE-AGM1OI2J-E	M4SE-AGM1OI2J-R
16	M4SI-8GM1NI0K-E	M4SI-8GM1NI0K-R
17	M4UE-8GM1JISJ-E	M4UE-8GM1JISJ-R
18	M4UE-AGM1KIRG-E	M4UE-AGM1KIRG-R
19	M4UE-AGM1KISJ-E	M4UE-AGM1KISJ-R

Notes:

- (1) For the replacement samples, DDR4 3200 Micron 1Gx8 R die WT IC assembled solutions are currently available.
- (2) No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones. Innodisk apologizes for any inconvenience caused by this and appreciates your understanding.
- (3) Innodisk promises that new items deliver quality and reliability, and are JEDEC compliant. If there is any further inquiry about our products or product specification, please contact your Innodisk salesperson for support.
- (4) Innodisk reserves the right to process the product change if the PN is not listed.

DRAM BU Vice President
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Samson Chang